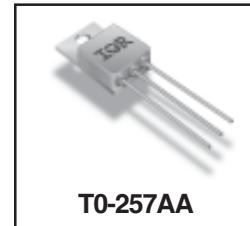


# International IR Rectifier

## RADIATION HARDENED POWER MOSFET THRU-HOLE (TO-257AA)

PD - 94663A

**IRHY597034CM**  
**60V, P-CHANNEL**  
**R5 TECHNOLOGY™**



**TO-257AA**

### Product Summary

Part Number	Radiation Level	R <sub>Ds(on)</sub>	I <sub>D</sub>
IRHY597034CM	100K Rads (Si)	0.095Ω	-18A*
IRHY593034CM	300K Rads (Si)	0.095Ω	-18A*

International Rectifier's R5™ technology provides high performance power MOSFETs for space applications. These devices have been characterized for Single Event Effects (SEE) with useful performance up to an LET of 80 (MeV/(mg/cm<sup>2</sup>)). The combination of low R<sub>Ds(on)</sub> and low gate charge reduces the power losses in switching applications such as DC to DC converters and motor control. These devices retain all of the well established advantages of MOSFETs such as voltage control, fast switching, ease of paralleling and temperature stability of electrical parameters.

### Features:

- Single Event Effect (SEE) Hardened
- Ultra Low R<sub>Ds(on)</sub>
- Low Total Gate Charge
- Simple Drive Requirements
- Ease of Parallelizing
- Hermetically Sealed
- Ceramic Eyelets
- Electrically Isolated
- Light Weight

### Absolute Maximum Ratings

### Pre-Irradiation

Parameter	Units	
I <sub>D</sub> @ V <sub>GS</sub> = -12V, T <sub>C</sub> = 25°C	A	Continuous Drain Current
I <sub>D</sub> @ V <sub>GS</sub> = -12V, T <sub>C</sub> = 100°C		Continuous Drain Current
I <sub>DM</sub>		Pulsed Drain Current ①
P <sub>D</sub> @ T <sub>C</sub> = 25°C	W	Max. Power Dissipation
	W/C	Linear Derating Factor
V <sub>GS</sub>	V	Gate-to-Source Voltage
E <sub>AS</sub>	mJ	Single Pulse Avalanche Energy ②
I <sub>AR</sub>	A	Avalanche Current ①
E <sub>AR</sub>	mJ	Repetitive Avalanche Energy ①
dV/dt	V/ns	Peak Diode Recovery dV/dt ③
T <sub>J</sub>	°C	Operating Junction
T <sub>STG</sub>		Storage Temperature Range
		Lead Temperature
		300 (0.063in/1.6mm from case for 10s )
		Weight
		4.3 ( Typical )
		g

\* Current is limited by package

For footnotes refer to the last page

**Electrical Characteristics @  $T_j = 25^\circ\text{C}$  (Unless Otherwise Specified)**

	Parameter	Min	Typ	Max	Units	Test Conditions
$\text{BV}_{\text{DSS}}$	Drain-to-Source Breakdown Voltage	-60	—	—	V	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_D = -1.0\text{mA}$
$\Delta \text{BV}_{\text{DSS}}/\Delta T_j$	Temperature Coefficient of Breakdown Voltage	—	-0.063	—	$\text{V}/^\circ\text{C}$	Reference to $25^\circ\text{C}$ , $\text{I}_D = -1.0\text{mA}$
$\text{R}_{\text{DS(on)}}$	Static Drain-to-Source On-State Resistance	—	—	0.095	$\Omega$	$\text{V}_{\text{GS}} = -12\text{V}, \text{I}_D = -12.5\text{A}$ <sup>④</sup>
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	-2.0	—	-4.0	V	$\text{V}_{\text{DS}} = \text{V}_{\text{GS}}, \text{I}_D = -1.0\text{mA}$
$\text{g}_{\text{fs}}$	Forward Transconductance	10	—	—	S ( $\text{A}/\text{V}$ )	$\text{V}_{\text{DS}} = -25\text{V}, \text{I}_{\text{DS}} = -12.5\text{A}$ <sup>④</sup>
$\text{I}_{\text{DSS}}$	Zero Gate Voltage Drain Current	—	—	-10	$\mu\text{A}$	$\text{V}_{\text{DS}} = -48\text{V}, \text{V}_{\text{GS}} = 0\text{V}$
		—	—	-25		$\text{V}_{\text{DS}} = -48\text{V}, \text{V}_{\text{GS}} = 0\text{V}, \text{T}_j = 125^\circ\text{C}$
$\text{I}_{\text{GSS}}$	Gate-to-Source Leakage Forward	—	—	-100	nA	$\text{V}_{\text{GS}} = -20\text{V}$
$\text{I}_{\text{GSS}}$	Gate-to-Source Leakage Reverse	—	—	100		$\text{V}_{\text{GS}} = 20\text{V}$
$\text{Q}_g$	Total Gate Charge	—	—	45	nC	$\text{V}_{\text{GS}} = -12\text{V}, \text{I}_D = -18\text{A}$
$\text{Q}_{\text{gs}}$	Gate-to-Source Charge	—	—	18		$\text{V}_{\text{DS}} = -30\text{V}$
$\text{Q}_{\text{gd}}$	Gate-to-Drain ('Miller') Charge	—	—	13		
$t_{\text{d(on)}}$	Turn-On Delay Time	—	—	20	ns	$\text{V}_{\text{DD}} = -30\text{V}, \text{I}_D = -18\text{A}, \text{V}_{\text{GS}} = 12\text{V}, \text{R}_G = 7.5\Omega$
$t_r$	Rise Time	—	—	120		
$t_{\text{d(off)}}$	Turn-Off Delay Time	—	—	45		
$t_f$	Fall Time	—	—	25		
$\text{L}_{\text{S}} + \text{L}_{\text{D}}$	Total Inductance	—	6.8	—	nH	Measured from drain lead (6mm/0.25in. from package) to source lead (6mm/0.25in. from package)
$\text{C}_{\text{iss}}$	Input Capacitance	—	1490	—	pF	$\text{V}_{\text{GS}} = 0\text{V}, \text{V}_{\text{DS}} = -25\text{V}$ $f = 1.0\text{MHz}$
$\text{C}_{\text{oss}}$	Output Capacitance	—	575	—		
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance	—	70	—		
$\text{R}_{\text{g}}$	Internal Gate Resistance	—	5.5	—	$\Omega$	$f = 1.73\text{MHz}$ , open drain

**Source-Drain Diode Ratings and Characteristics**

	Parameter	Min	Typ	Max	Units	Test Conditions
$\text{I}_{\text{S}}$	Continuous Source Current (Body Diode)	—	—	-18*	A	$\text{T}_j = 25^\circ\text{C}, \text{I}_{\text{S}} = -18\text{A}, \text{V}_{\text{GS}} = 0\text{V}$ <sup>④</sup>
$\text{I}_{\text{SM}}$	Pulse Source Current (Body Diode) <sup>①</sup>	—	—	-72		
$\text{V}_{\text{SD}}$	Diode Forward Voltage	—	—	-5.0	V	$\text{T}_j = 25^\circ\text{C}, \text{I}_{\text{F}} = -18\text{A}, \text{di/dt} \leq -100\text{A}/\mu\text{s}$
$\text{t}_{\text{rr}}$	Reverse Recovery Time	—	—	100	ns	$\text{V}_{\text{DD}} \leq -25\text{V}$ <sup>④</sup>
$\text{Q}_{\text{RR}}$	Reverse Recovery Charge	—	—	200	nC	
$t_{\text{on}}$	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $\text{L}_{\text{S}} + \text{L}_{\text{D}}$ .				

\* Current is limited by package

**Thermal Resistance**

	Parameter	Min	Typ	Max	Units	Test Conditions
$\text{R}_{\text{thJC}}$	Junction-to-Case	—	—	1.67	$^\circ\text{C}/\text{W}$	Typical Socket Mount
$\text{R}_{\text{thJA}}$	Junction-to-Ambient	—	—	80		

Note: Corresponding Spice and Saber models are available on International Rectifier Web site.

For footnotes refer to the last page

## Radiation Characteristics

**IRHY597034CM**

International Rectifier Radiation Hardened MOSFETs are tested to verify their radiation hardness capability. The hardness assurance program at International Rectifier is comprised of two radiation environments. Every manufacturing lot is tested for total ionizing dose (per notes 5 and 6) using the TO-3 package. Both pre- and post-irradiation performance are tested and specified using the same drive circuitry and test conditions in order to provide a direct comparison.

**Table 1. Electrical Characteristics @  $T_j = 25^\circ\text{C}$ , Post Total Dose Irradiation** <sup>(5)(6)</sup>

	Parameter	100K Rads(Si) <sup>1</sup>		300KRads(Si) <sup>2</sup>		Units	Test Conditions
		Min	Max	Min	Max		
$\text{BV}_{\text{DSS}}$	Drain-to-Source Breakdown Voltage	-60	—	-60	—	V	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_D = -1.0\text{mA}$
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	-2.0	-4.0	-2.0	-5.0		$\text{V}_{\text{GS}} = \text{V}_{\text{DS}}, \text{I}_D = -1.0\text{mA}$
$\text{I}_{\text{GSS}}$	Gate-to-Source Leakage Forward	—	-100	—	-100	nA	$\text{V}_{\text{GS}} = -20\text{V}$
$\text{I}_{\text{GSS}}$	Gate-to-Source Leakage Reverse	—	100	—	100		$\text{V}_{\text{GS}} = 20\text{ V}$
$\text{I}_{\text{DSS}}$	Zero Gate Voltage Drain Current	—	-10	—	-10	$\mu\text{A}$	$\text{V}_{\text{DS}} = -48\text{V}, \text{V}_{\text{GS}} = 0\text{V}$
$\text{R}_{\text{DS(on)}}$	Static Drain-to-Source <sup>(4)</sup> On-State Resistance (TO-3)	—	0.087	—	0.087	$\Omega$	$\text{V}_{\text{GS}} = -12\text{V}, \text{I}_D = -12.5\text{A}$
$\text{R}_{\text{DS(on)}}$	Static Drain-to-Source <sup>(4)</sup> On-State Resistance (TO-257AA)	—	0.095	—	0.095	$\Omega$	$\text{V}_{\text{GS}} = -12\text{V}, \text{I}_D = -12.5\text{A}$
$\text{V}_{\text{SD}}$	Diode Forward Voltage <sup>(4)</sup>	—	-5.0	—	-5.0	V	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_S = -18\text{A}$

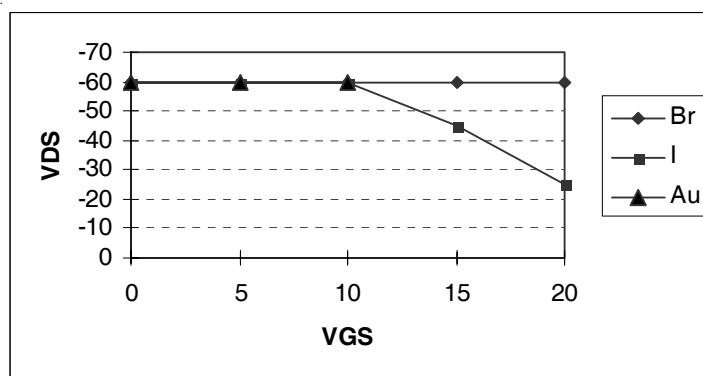
1. Part number IRHY597034CM

2. Part number IRHY593034CM

International Rectifier radiation hardened MOSFETs have been characterized in heavy ion environment for Single Event Effects (SEE). Single Event Effects characterization is illustrated in Fig. a and Table 2.

**Table 2. Single Event Effect Safe Operating Area**

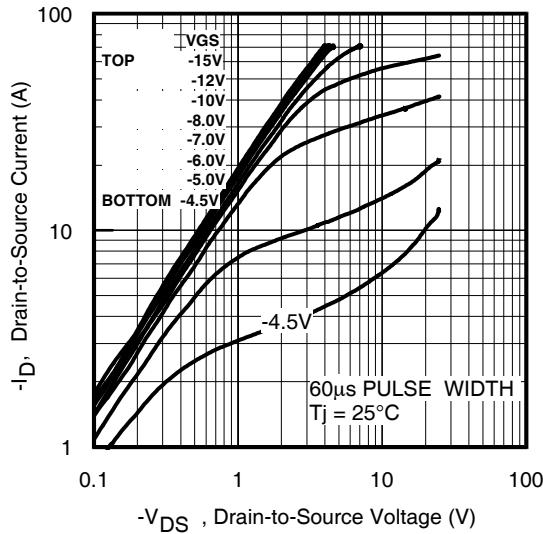
Ion	LET (MeV/(mg/cm <sup>2</sup> ))	Energy (MeV)	Range (μm)	V <sub>DS</sub> (V)				
				@V <sub>GS</sub> =0V	@V <sub>GS</sub> =5V	@V <sub>GS</sub> =10V	@V <sub>GS</sub> =15V	@V <sub>GS</sub> =20V
Br	37.9	252.6	33.1	- 60	- 60	- 60	- 60	- 60
I	59.7	314	30.5	- 60	- 60	- 60	- 45	- 25
Au	82.3	350	28.4	- 60	- 60	- 60	—	—



**Fig a.** Single Event Effect, Safe Operating Area

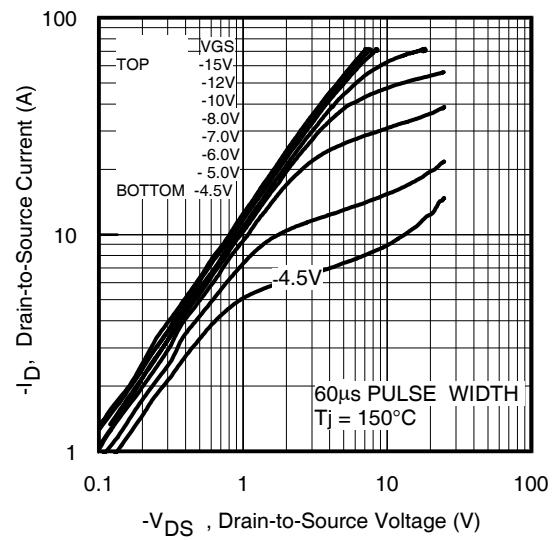
For footnotes refer to the last page

## IRHY597034CM

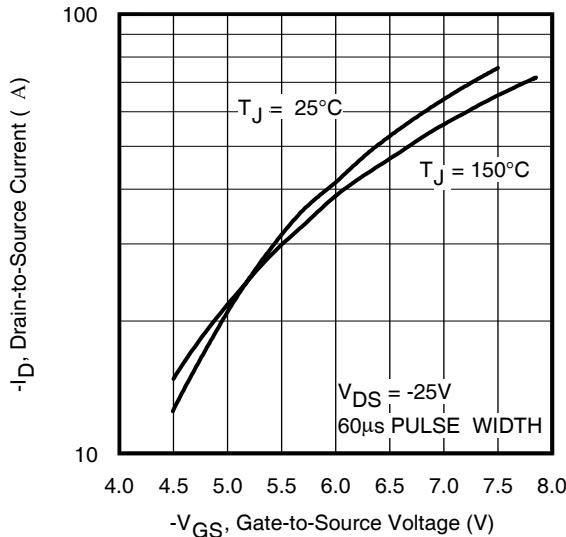


**Fig 1.** Typical Output Characteristics

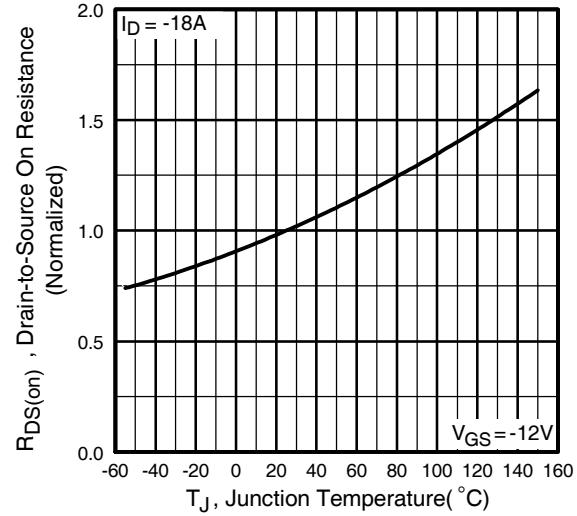
## Pre-Irradiation



**Fig 2.** Typical Output Characteristics



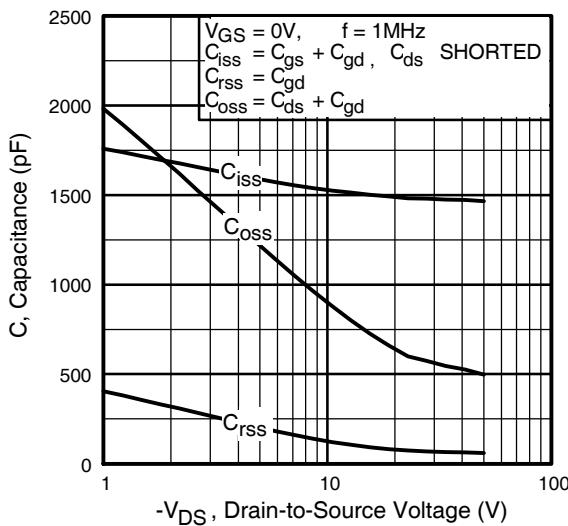
**Fig 3.** Typical Transfer Characteristics



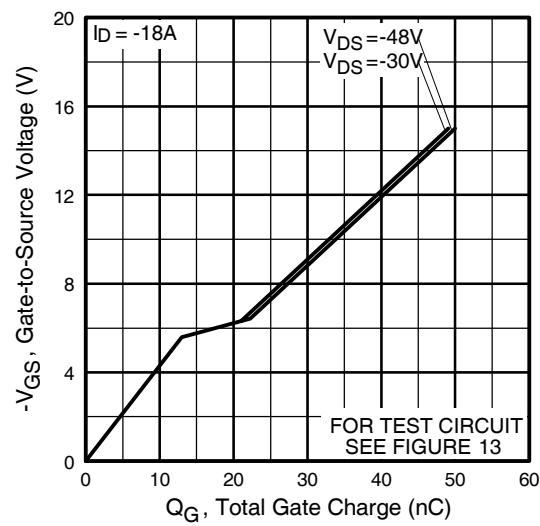
**Fig 4.** Normalized On-Resistance Vs. Temperature

## Pre-Irradiation

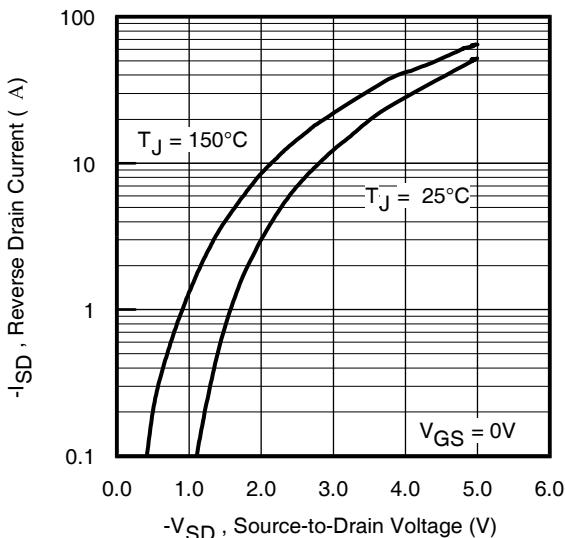
**IRHY597034CM**



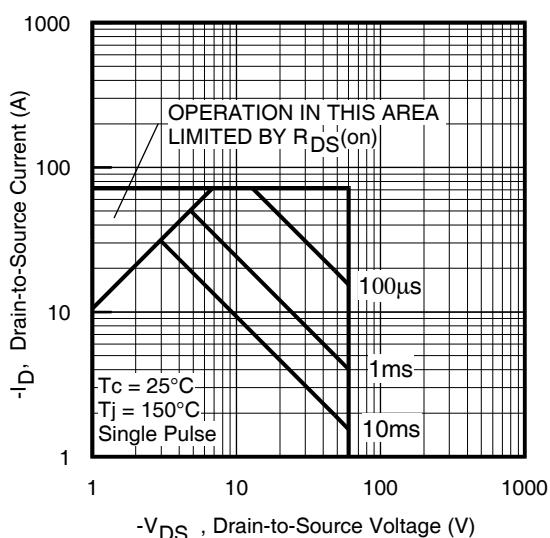
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



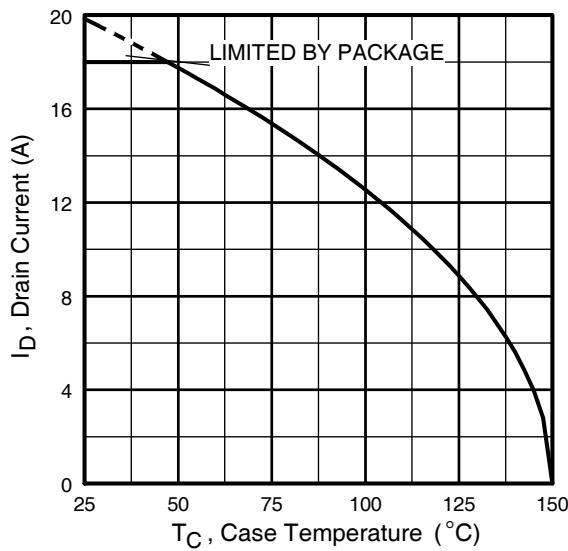
**Fig 7.** Typical Source-Drain Diode  
Forward Voltage



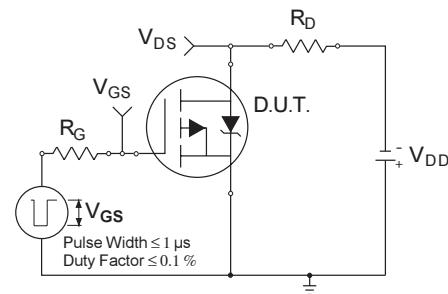
**Fig 8.** Maximum Safe Operating Area

## IRHY597034CM

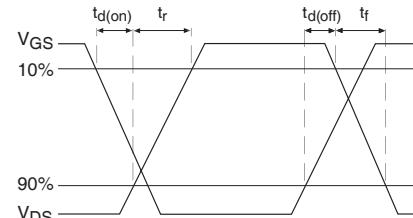
## Pre-Irradiation



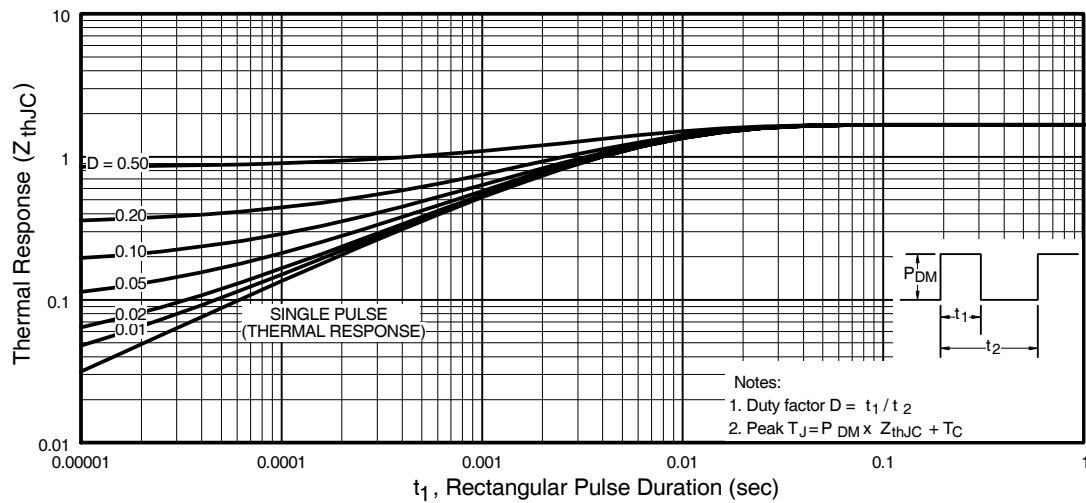
**Fig 9.** Maximum Drain Current Vs.  
Case Temperature



**Fig 10a.** Switching Time Test Circuit



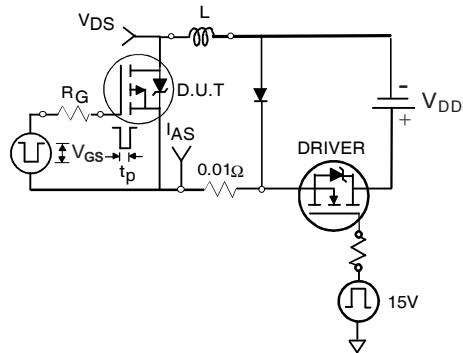
**Fig 10b.** Switching Time Waveforms



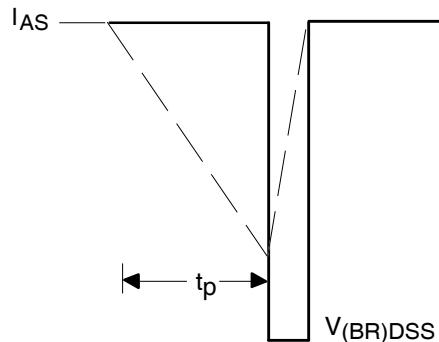
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

## Pre-Irradiation

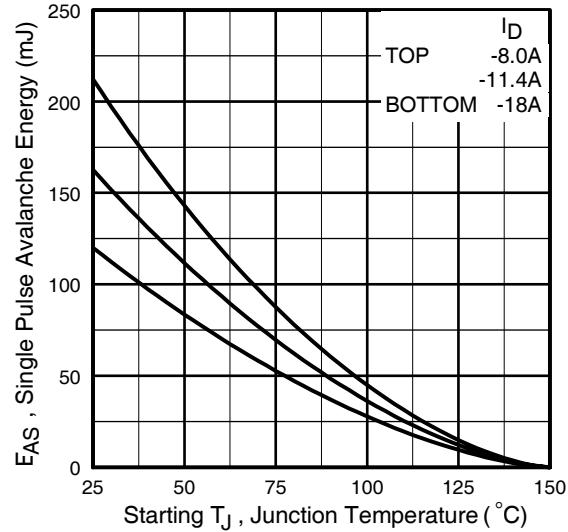
**IRHY597034CM**



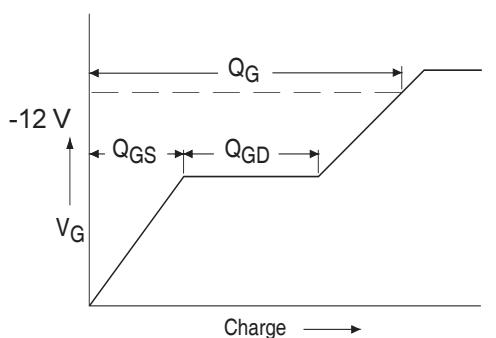
**Fig 12a.** Unclamped Inductive Test Circuit



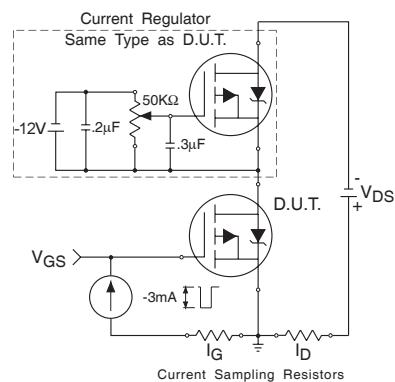
**Fig 12b.** Unclamped Inductive Waveforms



**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current



**Fig 13a.** Basic Gate Charge Waveform



**Fig 13b.** Gate Charge Test Circuit

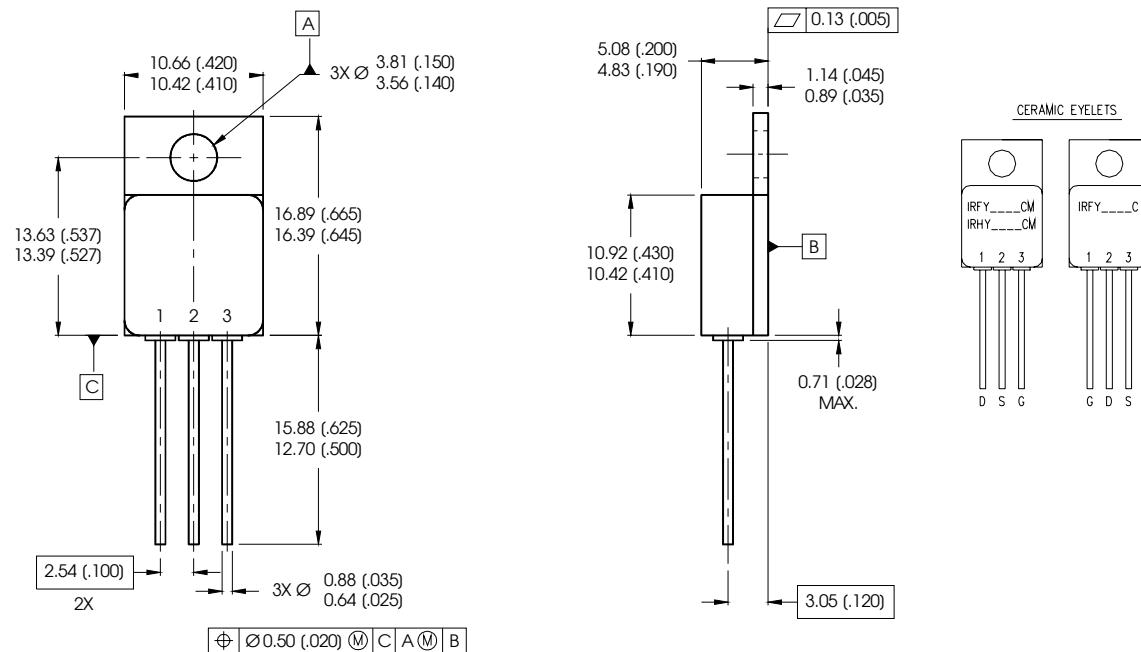
# IRHY597034CM

## Pre-Irradiation

### Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ②  $V_{DD} = -25V$ , starting  $T_J = 25^\circ C$ ,  $L = 0.74mH$   
Peak  $I_L = -18A$ ,  $V_{GS} = -12V$
- ③  $I_{SD} \leq -18A$ ,  $dI/dt \leq -370A/\mu s$ ,  
 $V_{DD} \leq -60V$ ,  $T_J \leq 150^\circ C$
- ④ Pulse width  $\leq 300 \mu s$ ; Duty Cycle  $\leq 2\%$
- ⑤ **Total Dose Irradiation with  $V_{GS}$  Bias.**  
-12 volt  $V_{GS}$  applied and  $V_{DS} = 0$  during irradiation per MIL-STD-750, method 1019, condition A.
- ⑥ **Total Dose Irradiation with  $V_{DS}$  Bias.**  
-48 volt  $V_{DS}$  applied and  $V_{GS} = 0$  during irradiation per MIL-STD-750, method 1019, condition A.

### Case Outline and Dimensions — TO-257AA



#### NOTES:

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.

#### LEGEND

- D – DRAIN  
S – SOURCE  
G – GATE

International  
**IR** Rectifier

**IR WORLD HEADQUARTERS:** 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105

**IR LEOMINSTER :** 205 Crawford St., Leominster, Massachusetts 01453, USA Tel: (978) 534-5776

TAC Fax: (310) 252-7903

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